

PLEASE ENTER
5/17/2007

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/530,343 Confirmation No. : 7755
First Named Inventor : Ralf LERNER, et al.
Filed : April 6, 2005
TC/A.U. : 2823
Examiner : William D. Coleman

Docket No. : 60291.000034
Customer No. : 21967

Title : TRENCH INSULATION IN SUBSTRATE DISKS COMPRISING
LOGIC SEMICONDUCTORS AND POWER SEMICONDUCTORS

AMENDMENT UNDER 37 C.F.R. § 1.312

MAIL STOP ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.312, Applicants submit the following Amendments.

Applicants respectfully request that the application be amended as set forth herein. The amendment is to expedite grant and does not introduce new issues.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.